

## Description

The DIODES™ 74LVC2G34 is a dual buffer gate with standard push-pull outputs. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

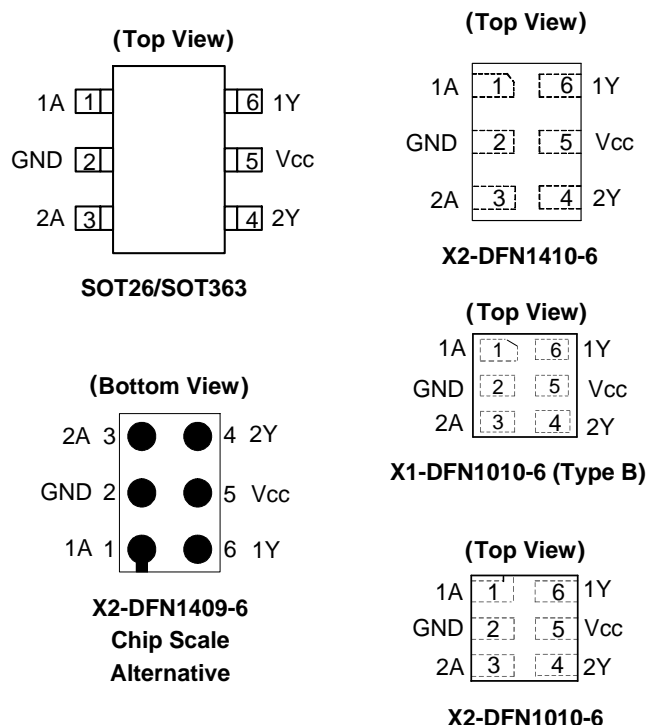
$$Y = A$$

## Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- ±24mA Output Drive at 3.0V
- CMOS Low Power Consumption
- I<sub>OFF</sub> Supports Partial-Power-Down Mode Operation
- Inputs Accept up to 5.5V
- ESD Protection Tested per JESD 22
- Exceeds 2000V Human Body Model (A114)
- Exceeds 1000V Charged Device Model (C101)
- Latch-up Exceeds 100mA per JESD 78, Class I
- X2-DFN1409-6 Package Designed as a Direct Replacement for Chip Scale Packaging
- Range of Package Options SOT26, SOT363, X1-DFN1010-6 (Type B), X2-DFN1010-6, X2-DFN1409-6, and X2-DFN1410-6
- Leadless Packages Named per JESD30E
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Pin Assignments



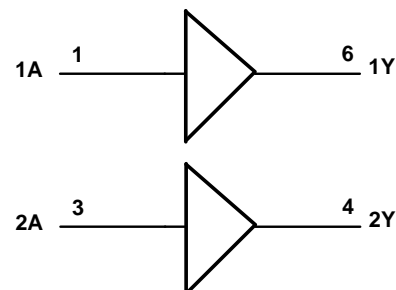
## Applications

- Voltage level shifting
- General purpose logics
- Power down signal isolations
- Wide array of products such as:
  - PCs, networking, notebooks, netbooks, tablets
  - Computer peripherals, hard drives, SSD, CD/DVD ROM
  - TV, DVD, DVR, set-top boxes
  - Cell phones, personal navigations/GPS
  - MP3 players, cameras, video recorders

## Pin Descriptions

| Pin Number | Pin Name        | Function       |
|------------|-----------------|----------------|
| 1          | 1A              | Data Input     |
| 2          | GND             | Ground         |
| 3          | 2A              | Data Input     |
| 4          | 2Y              | Data Output    |
| 5          | V <sub>CC</sub> | Supply Voltage |
| 6          | 1Y              | Data Output    |

## Logic Diagram



## Function Table

| Inputs | Output |
|--------|--------|
| A      | Y      |
| H      | H      |
| L      | L      |

## Absolute Maximum Ratings (Notes 4 & 5) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol           | Parameter   | Rating                       | Unit |
|------------------|---|------------------------------|------|
| ESD HBM          | Human Body Model ESD Protection                                       | 2                            | kV   |
| ESD CDM          | Charged Device Model ESD Protection                                   | 1                            | kV   |
| V <sub>CC</sub>  | Supply Voltage Range  | -0.5 to +6.5                 | V    |
| V <sub>I</sub>   | Input Voltage Range   | -0.5 to +6.5                 | V    |
| V <sub>O</sub>   | Voltage Applied to Output in High Impedance or I <sub>OFF</sub> State | -0.5 to +6.5                 | V    |
| V <sub>O</sub>   | Voltage Applied to Output in High or Low State                        | -0.3 to V <sub>CC</sub> +0.5 | V    |
| I <sub>IK</sub>  | Input Clamp Current V <sub>I</sub> < 0                                | -50                          | mA   |
| I <sub>OK</sub>  | Output Clamp Current V <sub>O</sub> < 0                               | -50                          | mA   |
| I <sub>O</sub>   | Continuous Output Current   | -50                          | mA   |
| —                | Continuous Current through V <sub>DD</sub> or GND                     | ±100                         | mA   |
| T <sub>J</sub>   | Operating Junction Temperature  | -40 to +150                  | °C   |
| T <sub>STG</sub> | Storage Temperature   | -65 to +150                  | °C   |

- Notes:
- Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.
  - Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

**Recommended Operating Conditions** (Note 6) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol          | Parameter                          |   | Min                    | Max                    | Unit |    |
|-----------------|------------------------------------|---|------------------------|------------------------|------|----|
| V <sub>CC</sub> | Operating Voltage                  | Operating                                   | 1.65                   | 5.5                    | V    |    |
|                 |                                    | Data Retention Only                         | 1.5                    | —                      | V    |    |
| V <sub>IH</sub> | High-Level Input Voltage           | V <sub>CC</sub> = 1.65V to 1.95V            | 0.65 x V <sub>CC</sub> | —                      | V    |    |
|                 |                                    | V <sub>CC</sub> = 2.3V to 2.7V              | 1.7                    | —                      |      |    |
|                 |                                    | V <sub>CC</sub> = 3V to 3.6V                | 2                      | —                      |      |    |
|                 |                                    | V <sub>CC</sub> = 4.5V to 5.5V              | 0.7 x V <sub>CC</sub>  | —                      |      |    |
| V <sub>IL</sub> | Low-Level Input Voltage            | V <sub>CC</sub> = 1.65V to 1.95V            | —                      | 0.35 x V <sub>CC</sub> | V    |    |
|                 |                                    | V <sub>CC</sub> = 2.3V to 2.7V              | —                      | 0.7                    |      |    |
|                 |                                    | V <sub>CC</sub> = 3V to 3.6V                | —                      | 0.8                    |      |    |
|                 |                                    | V <sub>CC</sub> = 4.5V to 5.5V              | —                      | 0.3 x V <sub>CC</sub>  |      |    |
| V <sub>I</sub>  | Input Voltage                      |   | 0                      | 5.5                    | V    |    |
| V <sub>O</sub>  | Output Voltage                     |   | 0                      | V <sub>CC</sub>        | V    |    |
| I <sub>OH</sub> | High-Level Output Current          | V <sub>CC</sub> = 1.65V                     | —                      | -4                     | mA   |    |
|                 |                                    | V <sub>CC</sub> = 2.3V                      | —                      | -8                     |      |    |
|                 |                                    | V <sub>CC</sub> = 3V                        | —                      | -16                    |      |    |
|                 |                                    | V <sub>CC</sub> = 4.5V                      | —                      | -32                    |      |    |
| I <sub>OL</sub> | Low-Level Output Current           | V <sub>CC</sub> = 1.65V                     | —                      | 4                      | mA   |    |
|                 |                                    | V <sub>CC</sub> = 2.3V                      | —                      | 8                      |      |    |
|                 |                                    | V <sub>CC</sub> = 3V                        | —                      | 16                     |      |    |
|                 |                                    | V <sub>CC</sub> = 4.5V                      | —                      | 32                     |      |    |
| Δt/ΔV           | Input Transition Rise or Fall Rate | V <sub>CC</sub> = 1.8V ± 0.15V, 2.5V ± 0.2V | —                      | 20                     | ns/V |    |
|                 |                                    | V <sub>CC</sub> = 3.3V ± 0.3V               | —                      | 10                     |      |    |
|                 |                                    | V <sub>CC</sub> = 5V ± 0.5V                 | —                      | 5                      |      |    |
| T <sub>A</sub>  | Operating Free-Air Temperature     |   | —                      | -40                    | +125 | °C |

Note: 6. Unused inputs should be held at V<sub>CC</sub> or Ground.

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol           | Parameter                  | Test Conditions                                  | V <sub>CC</sub> | +40°C to +85°C        |      | -40°C to +125°C       |      | Unit |      |
|------------------|----------------------------|--|-----------------|-----------------------|------|-----------------------|------|------|------|
|                  |                            |  |                 | Min                   | Max  | Min                   | Max  |      |      |
| V <sub>OH</sub>  | High-Level Output Voltage  | I <sub>OH</sub> = -100μA                         | 1.65V to 5.5V   | V <sub>CC</sub> - 0.1 | —    | V <sub>CC</sub> - 0.1 | —    | V    |      |
|                  |                            | I <sub>OH</sub> = -4mA                           | 1.65V           | 1.2                   | —    | 0.95                  | —    |      |      |
|                  |                            | I <sub>OH</sub> = -8mA                           | 2.3V            | 1.9                   | —    | 1.7                   | —    |      |      |
|                  |                            | I <sub>OH</sub> = -16mA                          | 3V              | 2.4                   | —    | 2.2                   | —    |      |      |
|                  |                            | I <sub>OH</sub> = -24mA                          |                 | 2.3                   | —    | 2.0                   | —    |      |      |
|                  |                            | I <sub>OH</sub> = -32mA                          | 4.5V            | 3.8                   | —    | 3.4                   | —    |      |      |
| V <sub>OL</sub>  | Low-Level Output Voltage   | I <sub>OL</sub> = 100μA                          | 1.65V to 5.5V   | —                     | 0.1  | —                     | 0.1  | V    |      |
|                  |                            | I <sub>OL</sub> = 4mA                            | 1.65V           | —                     | 0.45 | —                     | 0.70 |      |      |
|                  |                            | I <sub>OL</sub> = 8mA                            | 2.3V            | —                     | 0.3  | —                     | 0.45 |      |      |
|                  |                            | I <sub>OL</sub> = 16mA                           | 3V              | —                     | —    | 0.4                   | —    |      | 0.60 |
|                  |                            | I <sub>OL</sub> = 24mA                           |                 | —                     | —    | 0.55                  | —    |      | 0.80 |
|                  |                            | I <sub>OL</sub> = 32mA                           | 4.5V            | —                     | —    | 0.55                  | —    |      | 0.80 |
| I <sub>I</sub>   | Input Current              | V <sub>I</sub> = 5.5V or GND                     | 0 to 5.5V       | —                     | ±5   | —                     | ±20  | μA   |      |
| I <sub>OFF</sub> | Power Down Leakage Current | V <sub>I</sub> or V <sub>O</sub> = 5.5V          | 0               | —                     | ±10  | —                     | ±20  | μA   |      |
| I <sub>CC</sub>  | Supply Current             | V <sub>I</sub> = 5.5V or GND, I <sub>O</sub> = 0 | 1.65V to 5.5V   | —                     | 10   | —                     | 40   | μA   |      |
| ΔI <sub>CC</sub> | Additional Supply Current  | Input at V <sub>CC</sub> - 0.6V                  | 3V to 5.5V      | —                     | 500  | —                     | 5000 | μA   |      |

**Package Characteristics** (@T<sub>A</sub> = +25°C, V<sub>CC</sub> = 3.3V, unless otherwise specified.)

| Symbol          | Parameter                              | Package                 | Conditions  | Min | Typ | Max | Unit |
|-----------------|--|-------------------------|---|-----|-----|-----|------|
| C <sub>i</sub>  | Input Capacitance                      | Typical of All Packages | V <sub>CC</sub> = 3.3V<br>V <sub>I</sub> = V <sub>CC</sub> or GND | —   | 3.5 | —   | pF   |
| θ <sub>JA</sub> | Thermal Resistance Junction-to-Ambient | SOT26                   | (Note 7)  | —   | 204 | —   | °C/W |
|                 |  | SOT363                  |   | —   | 371 | —   |      |
|                 |  | X2-DFN1410-6            |   | —   | 430 | —   |      |
|                 |  | X2-DFN1409-6            |   | —   | 450 | —   |      |
|                 |  | X1-DFN1010-6 (Type B)   |   | —   | 495 | —   |      |
|                 |  | X2-DFN1010-6            |   | —   | 510 | —   |      |
| θ <sub>JC</sub> | Thermal Resistance Junction-to-Case    | SOT26                   | (Note 7)  | —   | 52  | —   | °C/W |
|                 |  | SOT363                  |   | —   | 143 | —   |      |
|                 |  | X2-DFN1410-6            |   | —   | 190 | —   |      |
|                 |  | X2-DFN1409-6            |   | —   | 225 | —   |      |
|                 |  | X1-DFN1010-6 (Type B)   |   | —   | 245 | —   |      |
|                 |  | X2-DFN1010-6            |   | —   | 250 | —   |      |

Note: 7. Test condition for all packages: Device mounted on FR-4 substrate PC board, 2oz copper with minimum recommended pad layout.

**Switching Characteristics**

T<sub>A</sub> = -40°C to +85°C, C<sub>L</sub> = 30 or 50pF (See Figure 1)

| Parameter       | From (Input) | To (Output) | V <sub>CC</sub> = 1.8V ±0.15V |     | V <sub>CC</sub> = 2.5V ±0.2V |     | V <sub>CC</sub> = 3.3V ±0.3V |     | V <sub>CC</sub> = 5V ±0.5V |     | Unit |
|-----------------|--------------|-------------|-------------------------------|-----|------------------------------|-----|------------------------------|-----|----------------------------|-----|------|
|                 |              |             | Min                           | Max | Min                          | Max | Min                          | Max | Min                        | Max |      |
| t <sub>PD</sub> | A            | Y           | 0.5                           | 8.6 | 0.5                          | 4.4 | 0.5                          | 4.1 | 0.5                        | 3.2 | ns   |

T<sub>A</sub> = -40°C to +125°C, C<sub>L</sub> = 30 or 50pF (See Figure 1)

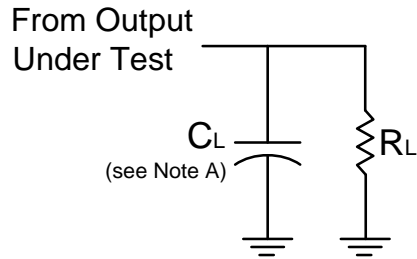
| Parameter       | From (Input) | To (Output) | V <sub>CC</sub> = 1.8V ±0.15V |      | V <sub>CC</sub> = 2.5V ±0.2V |     | V <sub>CC</sub> = 3.3V ±0.3V |     | V <sub>CC</sub> = 5V ±0.5V |     | Unit |
|-----------------|--------------|-------------|-------------------------------|------|------------------------------|-----|------------------------------|-----|----------------------------|-----|------|
|                 |              |             | Min                           | Max  | Min                          | Max | Min                          | Max | Min                        | Max |      |
| t <sub>PD</sub> | A            | Y           | 0.5                           | 10.8 | 0.5                          | 5.5 | 0.5                          | 5.1 | 0.5                        | 4.0 | ns   |

**Operating Characteristics**

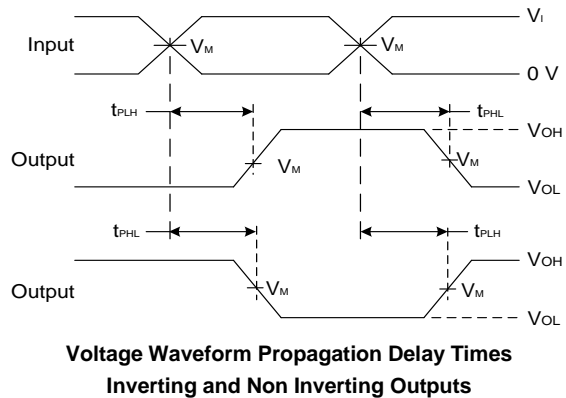
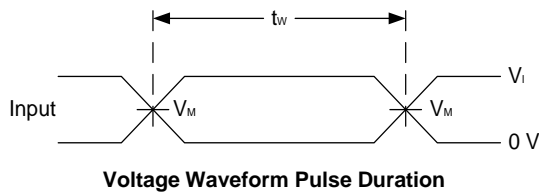
T<sub>A</sub> = +25°C

| Parameter       | Test Conditions | V <sub>CC</sub> = 1.8V | V <sub>CC</sub> = 2.5V | V <sub>CC</sub> = 3.3V | V <sub>CC</sub> = 5V | Unit |
|-----------------|-----------------|------------------------|------------------------|------------------------|----------------------|------|
|                 |                 | Typ                    | Typ                    | Typ                    | Typ                  |      |
| C <sub>PD</sub> | f = 10MHz       | 17                     | 19                     | 20                     | 21                   | pF   |

**Parameter Measurement Information**



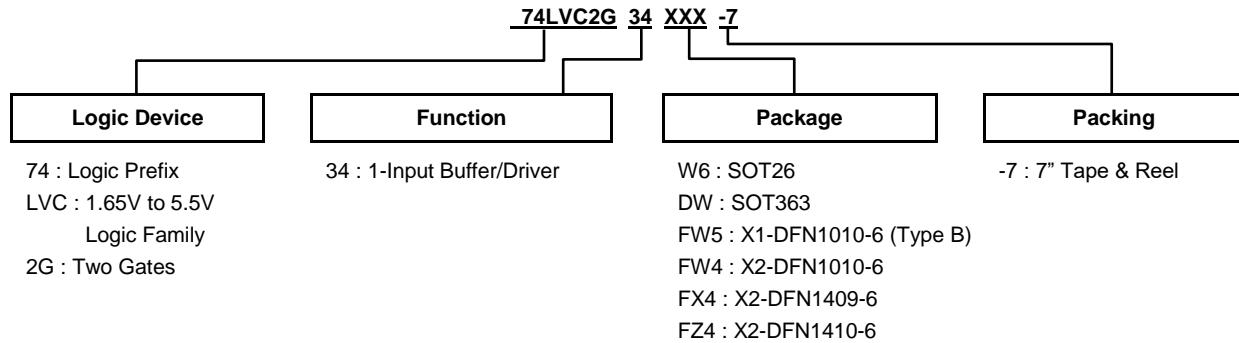
| $V_{CC}$         | Inputs   |              | $V_M$      | $C_L$ | $R_L$        |
|------------------|----------|--------------|------------|-------|--------------|
|                  | $V_I$    | $t_r/t_f$    |            |       |              |
| $1.8V \pm 0.15V$ | $V_{CC}$ | $\leq 2ns$   | $V_{CC}/2$ | 30pF  | 1k $\Omega$  |
| $2.5V \pm 0.2V$  | $V_{CC}$ | $\leq 2ns$   | $V_{CC}/2$ | 30pF  | 500 $\Omega$ |
| $3.3V \pm 0.3V$  | 3V       | $\leq 2.5ns$ | 1.5V       | 50pF  | 500 $\Omega$ |
| $5V \pm 0.5V$    | $V_{CC}$ | $\leq 2.5ns$ | $V_{CC}/2$ | 50pF  | 500 $\Omega$ |



**Figure 1. Load Circuit and Voltage Waveforms**

- Notes:
- A. Includes test lead and test apparatus capacitance.
  - B. All pulses are supplied at pulse repetition rate  $\leq 10MHz$ .
  - C. Inputs are measured separately one transition per measurement.
  - D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{PD}$ .

## Ordering Information



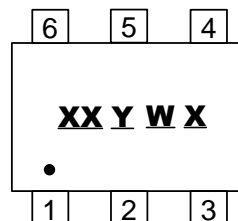
| Part Number    | Part Number Suffix | Package Code | Package (Note 8)                       | Package Size                               | Packing (Note 9) |             |
|----------------|--------------------|--------------|--|--|------------------|-------------|
|                |                    |              |  |  | Qty.             | Carrier     |
| 74LVC2G34W6-7  | -7                 | W6           | SOT26                                  | 2.8mm x 2.2mm x 1.1mm<br>0.95mm Lead Pitch | 3000             | Tape & Reel |
| 74LVC2G34DW-7  | -7                 | DW           | SOT363                                 | 2.0mm x 2.0mm x 1.1mm<br>0.65mm Lead Pitch | 3000             | Tape & Reel |
| 74LVC2G34FW5-7 | -7                 | FW5          | X1-DFN1010-6 (Type B)                  | 1.0mm x 1.0mm x 0.5mm<br>0.35mm Pad Pitch  | 5000             | Tape & Reel |
| 74LVC2G34FW4-7 | -7                 | FW4          | X2-DFN1010-6                           | 1.0mm x 1.0mm x 0.4mm<br>0.35mm Pad Pitch  | 5000             | Tape & Reel |
| 74LVC2G34FX4-7 | -7                 | FX4          | X2-DFN1409-6<br>Chip Scale Alternative | 1.4mm x 0.9mm x 0.4mm<br>0.5mm Pad Pitch   | 5000             | Tape & Reel |
| 74LVC2G34FZ4-7 | -7                 | FZ4          | X2-DFN1410-6                           | 1.4mm x 1.0mm x 0.4mm<br>0.5mm Pad Pitch   | 5000             | Tape & Reel |

Notes: 8. Pad layout as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.  
 9. The taping orientation is located on our website <https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf>.

## Marking Information

(1) SOT26, SOT363

(Top View)



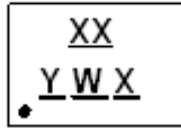
**XX**: Identification Code  
**Y**: Year 0 to 9 (ex: 2 = 2022)  
**W**: Week: A to Z: Week 1 to 26;  
 a to z: Week 27 to 52; z Represents  
 Week 52 and 53  
**X**: A to Z: Internal Code

| Part Number   | Package | Identification Code |
|---------------|---------|---------------------|
| 74LVC2G34W6-7 | SOT26   | Z7                  |
| 74LVC2G34DW-7 | SOT363  | Z7                  |

**Marking Information** (continued)

(2) X1-DFN1010-6 (Type B), X2-DFN1010-6, X2-DFN1409-6, X2-DFN1410-6

(Top View)



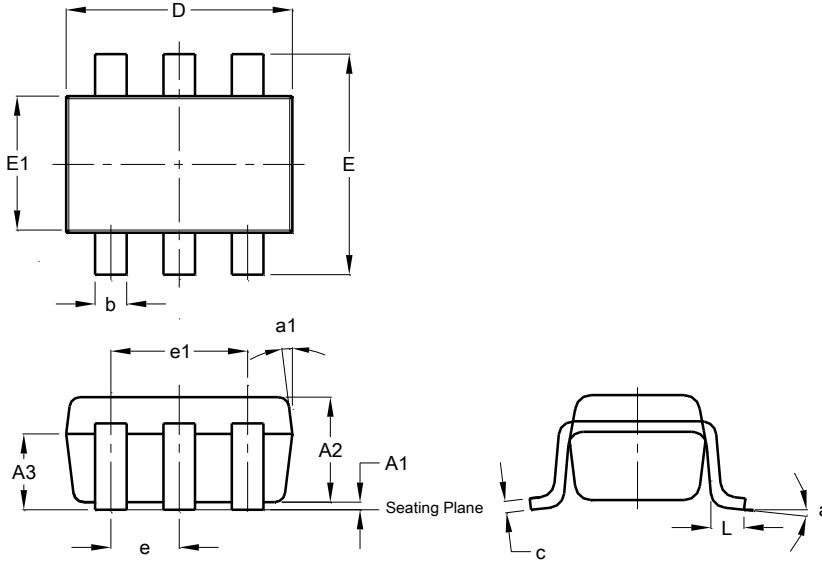
- XX: Identification Code
- Y: Year 0 to 9 (ex: 2 = 2022)
- W: Week: A to Z: Week 1 to 26;  
a to z: Week 27 to 52; z Represents  
Week 52 and 53
- X: A to Z: Internal Code

| Part Number    | Package               | Identification Code |
|----------------|-----------------------|---------------------|
| 74LVC2G34FW4-7 | X2-DFN1010-6          | Z7                  |
| 74LVC2G34FW5-7 | X1-DFN1010-6 (Type B) | W7                  |
| 74LVC2G34FX4-7 | X2-DFN1409-6          | X7                  |
| 74LVC2G34FZ4-7 | X2-DFN1410-6          | Z7                  |

**Package Outline Dimensions**

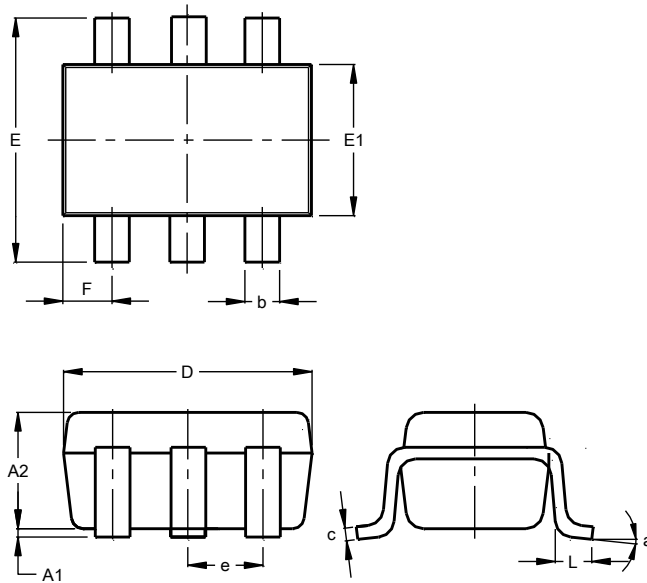
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT26**



| SOT26                |       |      |      |
|----------------------|-------|------|------|
| Dim                  | Min   | Max  | Typ  |
| A1                   | 0.013 | 0.10 | 0.05 |
| A2                   | 1.00  | 1.30 | 1.10 |
| A3                   | 0.70  | 0.80 | 0.75 |
| b                    | 0.35  | 0.50 | 0.38 |
| c                    | 0.10  | 0.20 | 0.15 |
| D                    | 2.90  | 3.10 | 3.00 |
| e                    | -     | -    | 0.95 |
| e1                   | -     | -    | 1.90 |
| E                    | 2.70  | 3.00 | 2.80 |
| E1                   | 1.50  | 1.70 | 1.60 |
| L                    | 0.35  | 0.55 | 0.40 |
| a                    | -     | -    | 8°   |
| a1                   | -     | -    | 7°   |
| All Dimensions in mm |       |      |      |

**SOT363**



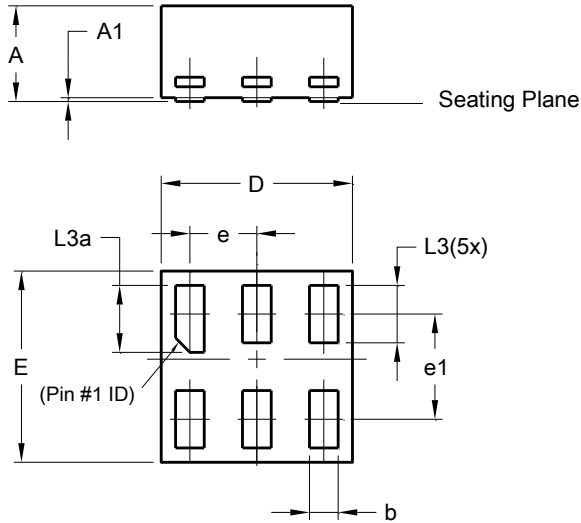
| SOT363               |           |      |       |
|----------------------|-----------|------|-------|
| Dim                  | Min       | Max  | Typ   |
| A1                   | 0.00      | 0.10 | 0.05  |
| A2                   | 0.90      | 1.00 | 0.95  |
| b                    | 0.10      | 0.30 | 0.25  |
| c                    | 0.10      | 0.22 | 0.11  |
| D                    | 1.80      | 2.20 | 2.15  |
| E                    | 2.00      | 2.20 | 2.10  |
| E1                   | 1.15      | 1.35 | 1.30  |
| e                    | 0.650 BSC |      |       |
| F                    | 0.40      | 0.45 | 0.425 |
| L                    | 0.25      | 0.40 | 0.30  |
| a                    | 0°        | 8°   | --    |
| All Dimensions in mm |           |      |       |



**Package Outline Dimensions** (continued)

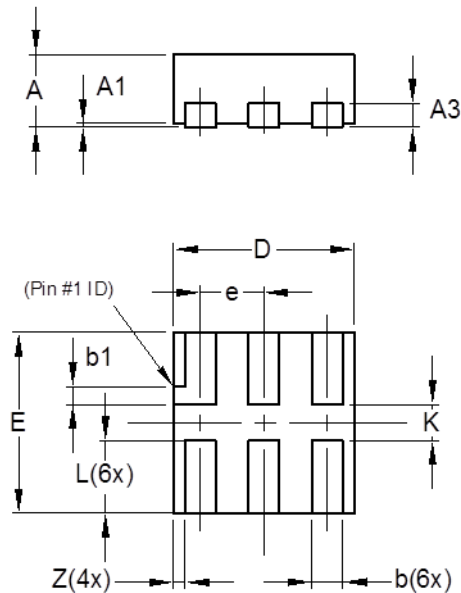
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X1-DFN1010-6 (Type B)**



| X1-DFN1010-6<br>(Type B) |          |       |      |
|--------------------------|----------|-------|------|
| Dim                      | Min      | Max   | Typ  |
| A                        | -        | 0.50  | 0.39 |
| A1                       | -        | 0.04  | -    |
| b                        | 0.12     | 0.20  | 0.15 |
| D                        | 0.95     | 1.050 | 1.00 |
| E                        | 0.95     | 1.050 | 1.00 |
| e                        | 0.35 BSC |       |      |
| e1                       | 0.55 BSC |       |      |
| L3                       | 0.27     | 0.30  | 0.30 |
| L3a                      | 0.32     | 0.40  | 0.35 |
| All Dimensions in mm     |          |       |      |

**X2-DFN1010-6**

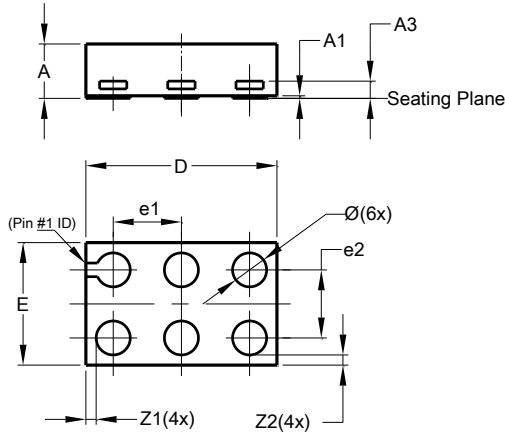


| X2-DFN1010-6         |      |      |       |
|----------------------|------|------|-------|
| Dim                  | Min  | Max  | Typ   |
| A                    | —    | 0.40 | 0.39  |
| A1                   | 0.00 | 0.05 | 0.02  |
| A3                   | —    | —    | 0.13  |
| b                    | 0.14 | 0.20 | 0.17  |
| b1                   | 0.05 | 0.15 | 0.10  |
| D                    | 0.95 | 1.05 | 1.00  |
| E                    | 0.95 | 1.05 | 1.00  |
| e                    | —    | —    | 0.35  |
| L                    | 0.35 | 0.45 | 0.40  |
| K                    | 0.15 | —    | —     |
| Z                    | —    | —    | 0.065 |
| All Dimensions in mm |      |      |       |

**Package Outline Dimensions** (continued)

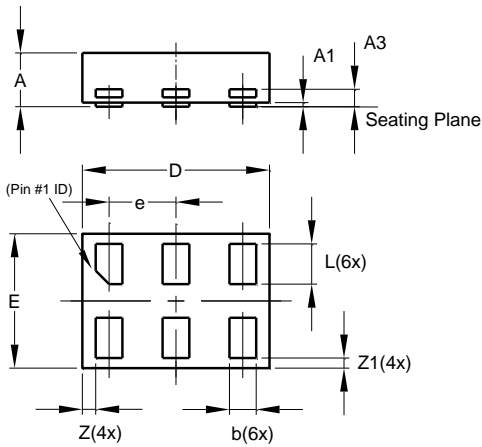
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X2-DFN1409-6**



| X2-DFN1409-6         |      |      |       |
|----------------------|------|------|-------|
| Dim                  | Min  | Max  | Typ   |
| A                    | -    | 0.40 | 0.39  |
| A1                   | 0    | 0.05 | 0.02  |
| A3                   | -    | -    | 0.13  |
| $\varnothing$        | 0.20 | 0.30 | 0.25  |
| D                    | 1.35 | 1.45 | 1.40  |
| E                    | 0.85 | 0.95 | 0.90  |
| e1                   | -    | -    | 0.50  |
| e2                   | -    | -    | 0.50  |
| Z1                   | -    | -    | 0.075 |
| Z2                   | -    | -    | 0.075 |
| All Dimensions in mm |      |      |       |

**X2-DFN1410-6**

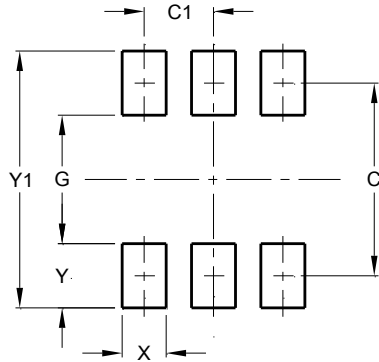


| X2-DFN1410-6         |       |       |       |
|----------------------|-------|-------|-------|
| Dim                  | Min   | Max   | Typ   |
| A                    | —     | 0.40  | 0.39  |
| A1                   | 0.00  | 0.05  | 0.02  |
| A3                   | —     | —     | 0.13  |
| b                    | 0.15  | 0.25  | 0.20  |
| D                    | 1.35  | 1.45  | 1.40  |
| E                    | 0.95  | 1.05  | 1.00  |
| e                    | —     | —     | 0.50  |
| L                    | 0.25  | 0.35  | 0.30  |
| Z                    | —     | —     | 0.10  |
| Z1                   | 0.045 | 0.105 | 0.075 |
| All Dimensions in mm |       |       |       |

## Suggested Pad Layout

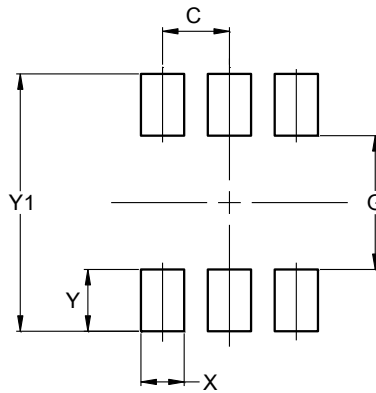
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT26



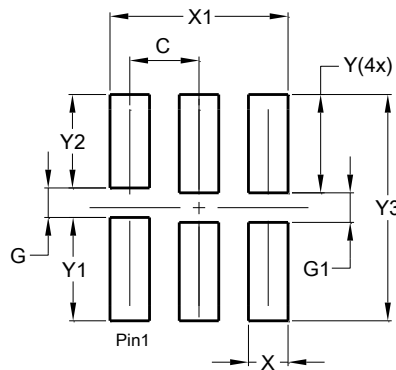
| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 2.40          |
| C1         | 0.95          |
| G          | 1.60          |
| X          | 0.55          |
| Y          | 0.80          |
| Y1         | 3.20          |

SOT363



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.650         |
| G          | 1.300         |
| X          | 0.420         |
| Y          | 0.600         |
| Y1         | 2.500         |

X1-DFN1010-6 (Type B)

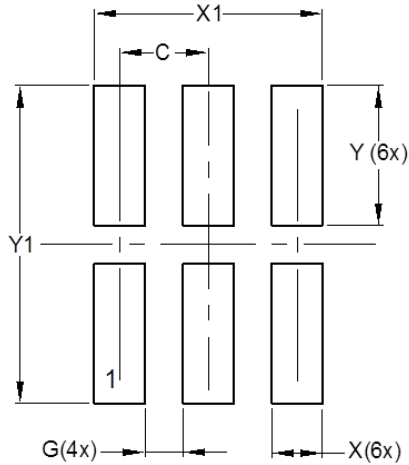


| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.350         |
| G          | 0.150         |
| G1         | 0.150         |
| X          | 0.200         |
| X1         | 0.900         |
| Y          | 0.500         |
| Y1         | 0.525         |
| Y2         | 0.475         |
| Y3         | 1.150         |

**Suggested Pad Layout** (continued)

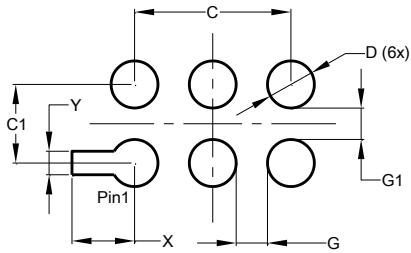
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X2-DFN1010-6**



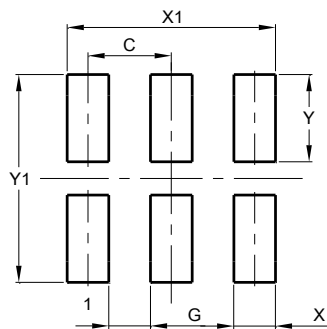
| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.350         |
| G          | 0.150         |
| X          | 0.200         |
| X1         | 0.900         |
| Y          | 0.550         |
| Y1         | 1.250         |

**X2-DFN1409-6**



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 1.000         |
| C1         | 0.500         |
| D          | 0.300         |
| G          | 0.200         |
| G1         | 0.200         |
| X          | 0.400         |
| Y          | 0.150         |

**X2-DFN1410-6**



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.500         |
| G          | 0.250         |
| X          | 0.250         |
| X1         | 1.250         |
| Y          | 0.525         |
| Y1         | 1.250         |

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## Mechanical Data

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### SOT26

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.016 grams (Approximate)

### SOT363

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.006 grams (Approximate)

### X1-DFN1010-6 (Type B)

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.001 grams (Approximate)

### X2-DFN1010-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.001 grams (Approximate)

### X2-DFN1409-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.002 grams (Approximate)

### X2-DFN1410-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.002 grams (Approximate)

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